Power MOSFET 40 V, 1.3 mΩ, 235 A, Single N–Channel

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C426NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.3 mΩ @ 10 V	235 A

D (5,6)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	40	V	
Gate-to-Source Voltage		V _{GS}	±20	V	
Continuous Drain		$T_{C} = 25^{\circ}C$	I _D	235	А
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		166	
Power Dissipation	State	T _C = 25°C	PD	128	W
R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$		64	
Continuous Drain		$T_A = 25^{\circ}C$	Ι _D	41	А
Current R _{0JA} (Notes 1, 2, 3)	Steady	T _A = 100°C		29	
Power Dissipation	State	T _A = 25°C	PD	3.8	W
$R_{\theta JA}$ (Notes 1 & 2)		$T_A = 100^{\circ}C$		1.9	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	900	А
Operating Junction and Storage Temperature		T _J , T _{stg}	–55 to + 175	°C	
Source Current (Body Diode)		۱ _S	122	А	
Single Pulse Drain–to–Source Avalanche Energy (I _{L(pk)} = 19 A)		E _{AS}	739	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

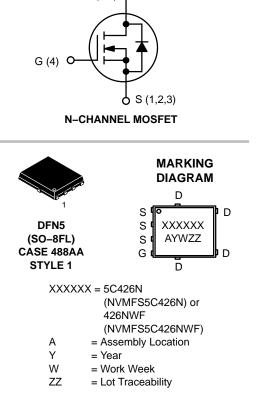
THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.2	°C/W
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

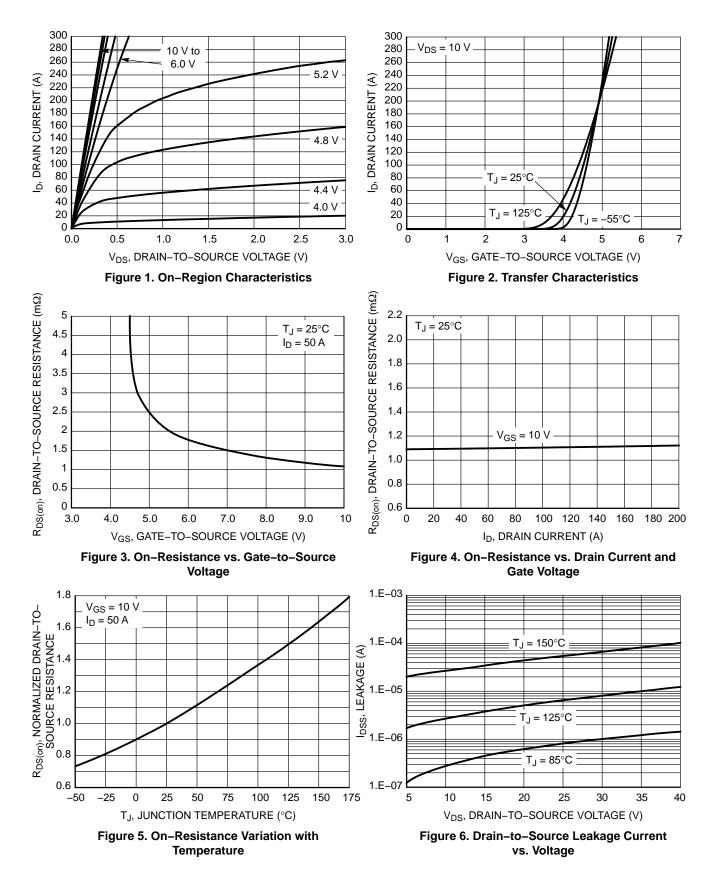
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS				-	-		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = 250 \mu A$		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / TJ				9.6		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	s $V_{GS} = 0 V,$ $V_{DS} = 40 V$ $T_{J} = 25^{\circ}C$ $T_{J} = 125^{\circ}C$				10	•
						100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	2.5		3.5	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-8.6		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		1.1	1.3	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _E	_D = 50 A		145		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	$V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}, V_{DS} = 25 \text{ V}$ $V_{GS} = 10 \text{ V}, V_{DS} = 20 \text{ V}; \text{ I}_{D} = 50 \text{ A}$			4300		pF
Output Capacitance	C _{OSS}				2100		
Reverse Transfer Capacitance	C _{RSS}				59		
Total Gate Charge	Q _{G(TOT)}				65		
Threshold Gate Charge	Q _{G(TH)}				13]
Gate-to-Source Charge	Q _{GS}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A			20		- nC
Gate-to-Drain Charge	Q _{GD}				12		
Plateau Voltage	V _{GP}				4.7		V
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 20 V, I _D = 50 A, R _G = 2.5 Ω			15		ns
Rise Time	tr				47		
Turn–Off Delay Time	t _{d(OFF)}				36		
Fall Time	t _f				9.0		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.82	1.2	V
	I _S = 50 Å	$T_J = 125^{\circ}C$		0.68		v	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			63		ns
Charge Time	t _a				34		
Discharge Time	t _b				29		
Reverse Recovery Charge	Q _{RR}				92		nC

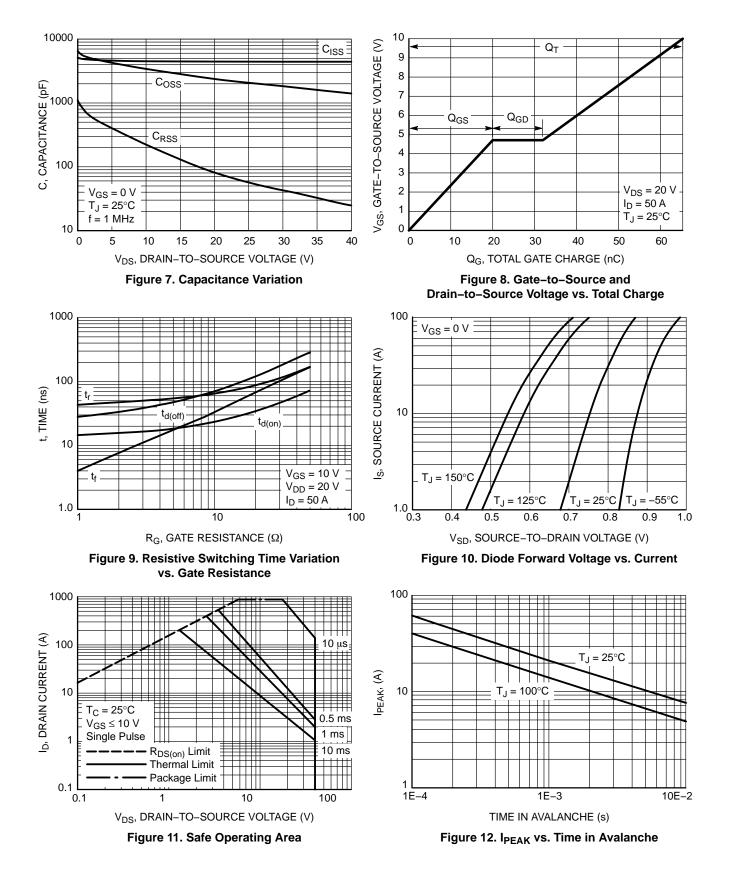
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

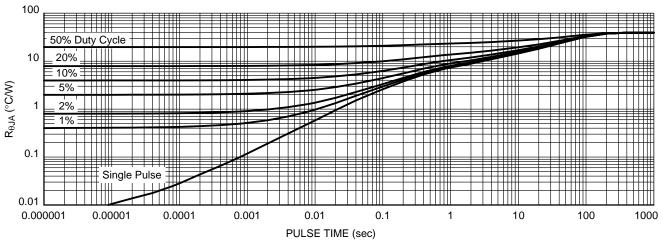
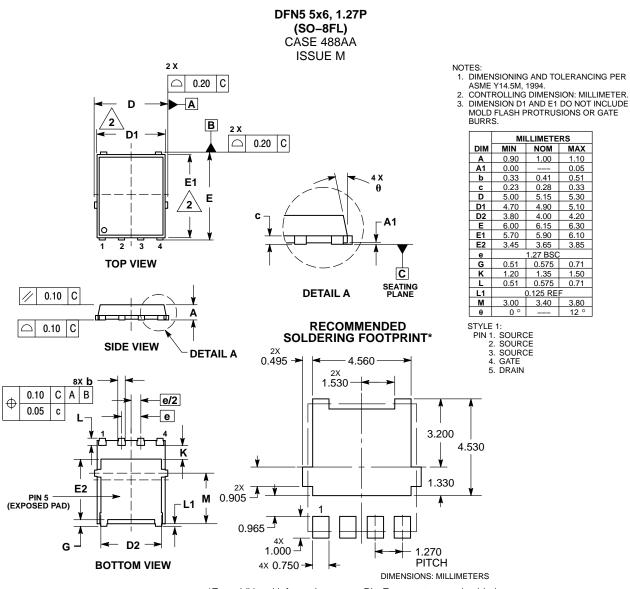


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping [†]
NVMFS5C426NT1G	5C426N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C426NWFT1G	426NWF	DFN5 (Pb–Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C426NT3G	5C426N	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C426NWFT3G	426NWF	DFN5 (Pb–Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C426NAFT1G	5C426N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C426NWFAFT1G	426NWF	DFN5 (Pb–Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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